

lothar.schermelleh@bioch.ox.ac.uk

Typical widefield image...



Optical resolution is diffraction limited!

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Optical resolution is diffraction limited!

Magnification alone does not give more details!

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... a little reminder:

"What determines the resolution of an optical microscope ?"



... a little reminder:

"What determines the resolution of an optical microscope ?"



"... a bit more difficult...?"



"… a bit more difficult…?"



What's the difference in brightness ?

"… a bit more difficult…?"



What's the difference in brightness ?

Numerical aperture determines ...

Brightness	$B = NA^4 / Mag^2$	(epifluorescence)
Lateral Resolution	$d_{x,y} = 0.61 \lambda / NA$	(200-300 nm)
Axial Resolution	$d_z = 2 \lambda / NA^2$	(500-700 nm)

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Only applies under optimal conditions! BUT ...

spherical aberrations chromatic aberrations straylight out-of-focus blur noise sample

Effective resolution is worse! (max. 250 nm lateral and $\leq 1 \ \mu m$ axial)

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...improved to some extent by Confocal LSM or Deconvolution





3D structured illumination microscopy

General overview of SR methods (4Pi, STED, SIM, Pointilism)

3D structured illumination microscopy

General overview of SR methods (4Pi, STED, SIM, Pointilism)

How Structured Illumination improves not only resolution ... & how it is realized in OMX

	Nea	r-field	Far-field					
Principle	Small aperture scanning (no lens)	Evanescent wave illumination	Widefield + deconvolution	Confocal laser scanning	Moiré effect with st	ructured illumination	PSF shaping with saturated emission depletion	Photoswitching and localiza- tion of single molecules (pointillism)
Acronym	SNOM/NSOM	TIRFM		CLSM	SIM (HELM, PEM) 3D-SIM	SSIM (SPEM)	STED/CW-STED	PALM/FPALM/STORM/ dSTORM/PALMIRA
Illumination-emission dependence	Linear	Linear	Linear	Linear	Linear	Non-linear	Non-linear	Linear
Detector	Scanning PMT/APD	Wide-field CCD/ CMOS	Widefield CCD/ CMOS	Scanning PMT/ APD	Wide-field CCD/ CMOS	Wide-field CCD/ CMOS	Scanning PMT/APD	Wide-field CCD/CMOS
XY-resolution	20-120 nm	200-300 nm	180-250 nm	180-250 nm	100-130 nm	50 nm	20-100 nm	20-50 nm
Z-resolution	10 nm (near-field range)	100 nm (near-field range)	500-700 nm	500700 nm	250-350 nm	N.D.	560 nm (CW-STED) to 700 nm (100 nm with z-phase mask)	100 nm (TIRF) 20–30 nm (3D-STORM, TIRF) 75 nm (BP-FPALM, in plane)
Serial z-sectioning	No	No	Yes	Yes	Yes	Yes	Yes	Yes
Z stack range	N.A.	N.A.	100 µm	100 µm	10-20 µm	N.A.	>20 µm	100 nm – few µm (BP-FPALM)
Dyes	Any	Any	Any	Arty	Most conventional dyes (photostable)	Dyes require special charao teristics	Dyes require special characteristics (CW-STED works with many conventional dyes)	Dyes require special characteristics
Simultaneous colors	2	3	>3	>3	3	1	2	2
Temporal resolution for 512 × 512 image	s-min	ms	ms	ms-s	ms-s	s-min	ms-min	s-min
Energy load/ intensity	Low	Low	Low	Medium	Medium	High	Medium-high	Medium-high
Live-cell imaging	Yes	Yes	Yes	Yes	Restricted (2D-TIRF)	No	Restricted	Restricted
Postprocessing required	No	No	Yes	No	Yes 9-25 raw images per slice	Yes ~100 raw images per slice	No	Yes > 1,000 raw images per slice
Notes	No intracellular imaging	Restricted to region near the coverslip	Risk of artifacts; better for sparse samples		Reconstruction bears risk of artefacts	High excitation required; recon- struction bears risk of artefacts	Complex instrumentation; photobleaching	May require TIRF setup for best performance; labeling density is critical; performs better on particles and filaments as on volume stains
Dual lens implementation			I-M	4Pi	15		4 Pi-STED/iso-STED	PALM
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Milestones in super-resolution microscopy





(S. Hell)

- Phase and wave front corrected interferometer to generate counter propagating coherent wavefronts
- Illumination and imaging from both sides,
- Confocal/multiphoton system for image acquisition





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- constructive interference of excitation and emission light
- 5-8 times higher **axial resolution**: 110nm resolution @780 nm
- Side lobes can be eliminated by deconvolution



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Problem: special sample requirements and need for physicist(s) to operate

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STED microscopy (Leica TCS)



STED microscopy (Leica TCS)


Resolving power of current commercial setups



Resolving power of current commercial setups



3D-SIM resolves ~8-fold smaller volumes than confocal laser scanning microscopy (CLSM)

Generating 3D-structured illumination



3 central diffracted beams the sample plane to generate sinusoidal stripes of ~220 nm width



adapted from Gustafsson et al. (2008) BiophysJ, 94

Generating 3D-structured illumination



axial modulation



adapted from Gustafsson et al. (2008) BiophysJ, 94

OMX: Housing



Dust filter

Optical filters

OMX: Stage



max. mechanical stability low thermal drift

OMX: Filter Drawer Design



OMX: Filter Drawer Design



OMX: Filter Drawer Design



max. mech. stability highest sensitivity

OMX: Dual illumination pathways



OMX: Laser unit



extendible / adaptable bread-board setup



ND-filters + shutters

OMX: Electronics rack













5 phases, 3 stacks

Reconstructed optical section

- each optical plane is recorded 15x ! (5 phases + 3 angles)
- typically ~1000 exposures per 8 µm stack (per wavelength)
- exposure time 10-100 ms; stack acquisition time few 10 seconds to minutes

Ist angle







Apotome uses coarse SI to remove out-of-focus blur





"Poor man's confocal" No super-resolution!





http://de.wikipedia.org/wiki/Ernst_Abbe





http://de.wikipedia.org/wiki/Ernst_Abbe













 $f_1 = 30$ Stripes / 300 Pixels = 0.1 S/P



periodicity



 $f_2 = 30$ Stripes / 270 Pixels = 0.11 S/P





MOIRE-PATTERNS are generated by "multiplication" SAMPLE PERIODICITY can be calculated!

 $f_1 = 30$ Stripes / 300 Pixels = 0.1 S/P

Illumination with known periodicity

 $f_2 = 30$ Stripes / 270 Pixels = 0.11 S/P





high frequency information is shifted/encoded to a lower frequency, that can be resolved.



unknown structure

high frequency information is shifted/encoded to a lower frequency, that can be resolved.

Fourier transform of the measured image

 $F\{f \times g\} = F\{f\} \otimes F\{g\} \longrightarrow F\{f\} = F\{f \times g\} \otimes^{-1} F\{g\}$ known illumination function

SI image reconstruction in Fourier space



SI image reconstruction in Fourier space








Illumination with known periodicity



Illumination with known periodicity













Support in 3D-frequency space

Widefield illumination



Support in 3D-frequency space



Example: 170 nm PS-Beads



Example: 170 nm PS-Beads



.











Microscopy Course 2012 - Lecture 13 42



What could this be?



What could this be?



3D information (z-res., optical sectioning, z-depth) !

What could this be?



3D information (z-res., optical sectioning, z-depth) !

What could this be?



3D information (z-res., optical sectioning, z-depth) !

Wide-field

Lamin B





Wide-field

Wide-field deconvolution

3D-SIM

Lamin B







3D context by z-sectioning...



....more context by 3D multicolor sectioning

Wide-field

Wide-field deconvolution

3D-SIM





....more context by 3D multicolor sectioning















Ιμm

3D SIM example: Prophase

Lamin B DAPI

3D volume rendering

3D SIM example: Prophase



Lamin B DAPI

3D volume rendering

3D SIM example: Telophase

Actin Tubulin DNA (DAPI) Standard Materials:

Coverslips #1.5 (d=0.170±0.005 mm) Blue: DAPI, CF405M, ATTO425 Green: Alexa 488, ATTO 488, GFP (?) Red: Alexa 594, ATTO 590, ATTO 594



Ray tracing rendering



3D SIM example: Nuclear pores

WF projections





DAPI



nup153 (Alexa-488)

3D SIM example: Nuclear pores


3D SIM example: Nuclear pores



Super-resolution microscopy: a multi-dimensional challenge



Which super-resolution method to use ?

3D-SIM	general method - 3 colors, 3D sectioning, only modest (x2) resolution gain in xy and z (x8 volumetric) postprocessing, prone to artifacts
Live 3D-SIM Non-linear SIM	OMX Blaze. Fast, large field-of-view (40 x40 μ m), high sensitivity experimental setup, dx,y 40-50 nm, currently restricted to TIRF and one color only (Dronpa)
TIRF SPIM	only near-field, improved z-resolution only, high sensitivity and temporal resolution, "surface biology" isotropic resolution (\sim 400 nm in xy, z) , deep imaging of large fields, large data, tissues and whole mounts
STED	high resolution, theoretically unlimited, WYSWG, speed scales with field of view special dye requirements, bleaching issues, complex instrumentation, works best in Hell's lab.
4Pi 15M	absolutely need a physicist. Little reported biology so far. same specimen mounting difficulties as 4Pi, no commercial implementation.
PALM/STORM	simple hardware. software more complex, various flavours, high localizization precision (~ 20 nm in x,y), structural resolution depends on labeling density, rather slow.

"All superresolution techniques excel in certain aspects and fail in others—the best technique will be determined by the demands of the application." Rego et al. 2012, PNAS





Credits to Jürgen Neumann, Pete Carlton and Timo Zimmermann for sharing slides